

BOARD'S DRILL SCHEDULE

DRILL SYMBOL	DRILL SIZE	COUNT	PLATED	Tolerance	COMMENT
	. 02	19	YES		
	. 041	5	YES		
\bigcirc	.047244094	22	YES		
	.051181102	4	NO		
\ominus	.07480315	28	YES		
	. 15	1	NO		
\oplus	. 16535433	7	NO		
	. 16929134	8	YES		
	. 17716535	1	NO		

2-Layer PCB - 85x75mm, 0.093" Thick

Board Characteristics

- 1. Material RF4 Tg > 170C
- 2. Minimum trace width: 0.2mm
- 3. 2 Oz Copper on all layers
- 4. Silkscreen on Component Side.
- 5. Soldermask on Top and Bottom, as per Gerbers
- 6. Au finish (ENIG).

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES . XX . XXX DO NOT SCALE DRAWING		CONTRACT NO.		UNIVERSITY OF CHICAGO ELECTRONICS DEVELOPMENT GROUP				
		APPROVALS	DATE	HELIX - OR/Shunt Board Specification Drawing				
TREATMENT		DRAWN M. Bogdan	4/8/2021					
FINISH		CHECKED M. Bogdan	4/8/2021	SIZE FSCM NO.	DWG.NO.	REV.		
		ISSUED			2995			
SIMILAR 10 ACI. WI	CALC WI			SCALE 1/1	SHEET			